

MM74HCT573N Datasheet



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DiGi Electronics Part Number MM74HCT573N-DG

Manufacturer onsemi

Manufacturer Product Number MM74HCT573N

Description IC D-TYPE TRANSP SGL 8:8 20DIP

Detailed Description D-Type Transparent Latch 1 Channel 8:8 IC Tri-Stat

e 20-PDIP



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MM74HCT573N	onsemi
Series:	Product Status:
74HCT	Obsolete
Logic Type:	Circuit:
D-Type Transparent Latch	8:8
Output Type:	Voltage - Supply:
Tri-State	4.5V ~ 5.5V
Independent Circuits:	Delay Time - Propagation:
Independent Circuits:	17ns
1	17ns
1 Current - Output High, Low:	17ns Operating Temperature:
1 Current - Output High, Low: 7.2mA, 7.2mA	17ns Operating Temperature: -40°C ~ 85°C
1 Current - Output High, Low: 7.2mA, 7.2mA Mounting Type:	17ns Operating Temperature: -40°C ~ 85°C Package / Case:

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8542.39.0001



Octal D-Type Latch / 3-STATE Octal D-Type Flip-Flop

MM74HCT573/MM74HCT574

General Description

The MM74HCT573 octal D-type latches and MM74HCT574 octal D-type flip-flop advanced silicon-gate CMOS technology, which provides the inherent benefits of low power consumption and wide power supply range, but are LS-TTL input and output characteristic and pin-out compatible. The 3-STATE outputs are capable of driving 15 LS-TTL loads. All inputs are protected from damage due to static discharge by internal diodes to $V_{\rm CC}$ and ground.

When the MM74HCT573 Latch Enable input is HIGH, the Q outputs will follow the D inputs. When the Latch Enable goes LOW, data at the D inputs will be retained at the outputs until Latch Enable returns HIGH again. When a high logic level is applied to the Output Control input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The MM74HCT574 are positive edge triggered flip-flops. Data at the D inputs, meeting the setup and hold time requirements, are transferred to the Q outputs on positive going transitions of the Clock (CK) input. When a high logic level is applied to the Output Control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Features

- TTL Input Characteristic Compatible
- Typical Propagation Delay: 17 ns
- Low Input Current: 1 µA Maximum
- Low Quiescent Current: 160 μA Maximum
- Compatible with Bus-oriented Systems
- Output Drive Capability: 15 LS-TTL Loads
- These are Pb-Free Devices



SOIC-20 WB CASE 751D-05

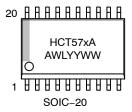


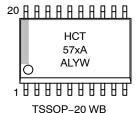
TSSOP20, 4.4x6.5 CASE 948AQ



TSSOP-20 WB CASE 948E

MARKING DIAGRAMS





HCT57xA = Specific Device Code

x = 3 or 4

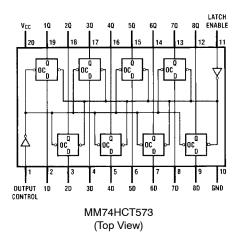
A = Assembly Location

WL, L = Wafer Lot YY, Y = Year WW, W = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

Connection Diagrams



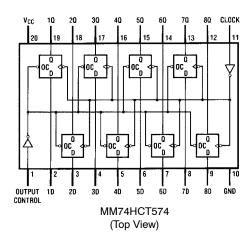


Figure 1. Pin Assignments for SOIC and TSSOP

Truth Tables

MM74HCT573

Output Control	LE	Data	373 Output
L	Н	Н	Н
L	Н	L	L
L	L	Х	Q_0
Н	Х	Х	Z

NOTES: H = HIGH Level

L = LOW Level

 $\label{eq:Q0} Q_0 \ = \mbox{Level of output before steady-state input} \\ \ \ \mbox{conditions were established}.$

Z = High Impedance State

MM74HCT574

Output Control	Clock	Data	374 Output
L	1	Н	Н
L	1	L	L
L	L	Х	Q_0
Н	Χ	Χ	Z

NOTES: H = HIGH Level

L = LOW Level

 $\label{eq:Q0} \textbf{Q}_0 \ = \text{The level of the output before steady state input} \\ \text{conditions were established.}$

X = Don't Care

Z = High Impedance State

↑ = Transition from LOW-to-HIGH

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol		Parameter		
V _{CC}	Supply Voltage		−0.5 to +7.0 V	
V _{IN}	DC Input Voltage		–0.5 to V _{CC} + 0.5 V	
V _{OUT}	DC Output Voltage		–0.5 to V _{CC} + 0.5 V	
I _{IK} , I _{OK}	Clamp Diode Current	±20 mA		
I _{OUT}	DC Output Current, per Pin	±35 mA		
I _{CC}	DC V _{CC} or GND Current, per Pin	±70 mA		
T _{STG}	Storage Temperature Range		–65°C to +150°C	
P _D	Power Dissipation S.O. Package only		500 mW	
TL	Lead Temperature (Soldering 10 S	260°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	Supply Voltage	4.5	5.5	V
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V
T _A	Operating Temperature Range	– 55	+125	°C
t _r , t _f	Input Rise or Fall Times		500	ns

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

^{1.} Unless otherwise specified all voltages are referenced to ground.

DC ELECTRICAL CHARACTERISTICS (V_{CC} = 5 V \pm 10%, unless otherwise specified)

			TA	= 25°C	T _A = -40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	Conditions	Тур	Gı	uaranteed Lim	nits	Unit
V _{IH}	Minimum HIGH Level Input Voltage		-	2.0	2.0	2.0	V
V _{IL}	Maximum LOW Level Input Voltage		-	0.8	0.8	0.8	V
V _{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} = 20 \mu A$	V _{CC}	V _{CC} – 0.1	V _{CC} - 0.1	V _{CC} - 0.1	V
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} = 6.0$ mA, $V_{CC} = 4.5$ V	4.2	3.98	3.84	3.7	٧
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} = 7.2$ mA, $V_{CC} = 5.5$ V	5.7	4.98	4.84	4.7	V
V _{OL}	Maximum LOW Level Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} = 20 \mu A$	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} = 6.0$ mA, $V_{CC} = 4.5$ V	0.2	0.26	0.33	0.4	V
		$V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} = 7.2$ mA, $V_{CC} = 5.5$ V	0.2	0.26	0.33	0.4	V
I _{IN}	Maximum Input Current	V _{IN} = V _{CC} or GND, V _{IH} or V _{IL}	-	±0.1	±1.0	±1.0	μΑ
I _{OZ}	Maximum 3-STATE Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, Enable = V_{IH} or V_{IL}	-	±0.5	±5.0	±10	μΑ
I _{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0 \mu A$	-	8.0	80	160	μΑ
		V _{IN} = 2.4 V or 0.5 V (Note 2)	-	1.5	1.8	2.0	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Measured per pin. All others tied to V_{CC} or ground.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT573: V_{CC} = 5.0 V, T_A = 25°C, t_r = t_f = 6 ns, unless otherwise specified)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay Data to Output	C _L = 45 pF	17	27	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay Latch Enable to Output	C _L = 45 pF	16	27	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	C_L = 45 pF R_L = 1 k Ω	21	30	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	$C_L = 5 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	14	23	ns
t _W	Minimum Clock Pulse Width		-	15	ns
t _S	Minimum Setup Time Data to Clock		_	5	ns
t _H	Minimum Hold Time Clock to Data		_	12	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT573: V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, unless otherwise specified)

			T _A =	25°C	T _A = -40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay Data to Output	C _L = 50 pF	18	30	38	45	ns
t _{PHL} , t _{PLH}	Maximum Propagation Delay Latch Enable to Output	C _L = 50 pF	17	30	44	53	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	22	30	38	45	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	$C_L = 50 \text{ pF}$ $R_L = 1 \text{ k}\Omega$	15	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	C _L = 50 pF	6	12	15	18	ns
t _W	Minimum Clock Pulse Width		-	15	20	24	ns
t _S	Minimum Setup Time Data to Clock		3	5	6	8	ns
t _H	Minimum Hold Time Clock to Data		4	12	15	18	ns
C _{IN}	Maximum Input Capacitance		-	10	10	10	pF
C _{OUT}	Maximum Output Capacitance		-	20	20	20	pF
C _{PD}	Power Dissipation Capacitance (Note 3)	OC = V _{CC}	-	5	-	-	pF
		OC = GND	-	52	-	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. C_{PD} determines the no load dynamic power consumption, P_D = C_{PD} V_{CC}² f + I_{CC} V_{CC}, and the no load dynamic current consumption, I_S = C_{PD} V_{CC}² f + I_{CC}.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT574: $V_{CC} = 5.0 \text{ V}$, $T_A = 25^{\circ}\text{C}$, $t_r = t_f = 6 \text{ ns}$)

Symbol	Parameter	Conditions	Тур	Guaranteed Limit	Unit
f _{MAX}	Maximum Clock Frequency		60	33	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay to Output	C _L = 45 pF	17	27	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	C_L = 45 pF R_L = 1 k Ω	19	28	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	C_L = 45 pF R_L = 1 k Ω	14	25	ns
t _W	Minimum Clock Pulse Width		-	15	ns
t _S	Minimum Setup Time Data to Clock		-	12	ns
t _H	Minimum Hold Time Clock to Data		-	5	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS

(MM74HCT574: V_{CC} = 5.0 V \pm 10%, t_r = t_f = 6 ns, unless otherwise specified)

			T _A =	25°C	T _A = -40°C to 85°C	T _A = -55°C to 125°C	
Symbol	Parameter	Conditions	Тур		Guaranteed L	imits	Unit
f _{MAX}	Maximum Clock Frequency		-	33	28	23	MHz
t _{PHL} , t _{PLH}	Maximum Propagation Delay Clock to Output	C _L = 50 pF	18	30	38	45	ns
t _{PZH} , t _{PZL}	Maximum Enable Propagation Delay Control to Output	C_L = 50 pF R_L = 1 k Ω	22	30	38	45	ns
t _{PHZ} , t _{PLZ}	Maximum Disable Propagation Delay Control to Output	C_L = 50 pF R_L = 1 k Ω	15	30	38	45	ns
t _{THL} , t _{TLH}	Maximum Output Rise and Fall Time	C _L = 50 pF	6	12	15	18	ns
t _W	Minimum Clock Pulse Width		-	15	20	24	ns
t _S	Minimum Setup Time Data to Clock		6	12	15	18	ns
t _H	Minimum Hold Time Clock to Data		1	5	6	8	ns
C _{IN}	Maximum Input Capacitance		_	10	10	10	pF
C _{OUT}	Maximum Output Capacitance		-	20	20	20	pF
C _{PD}	Power Dissipation Capacitance (Note 4)	OC = V _{CC}	5	_	-	-	pF
		OC = GND	58	_	-	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. CPD determines the no load dynamic power consumption, $P_D = C_{PD} \ V_{CC}^2 \ f + I_{CC} \ V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} \ V_{CC}^2 \ f + I_{CC}$.

ORDERING INFORMATION

Part Number	Package	Shipping [†]
MM74HCT573WMX	SOIC-20 WB, Case 751D-05 (Pb-Free and Halide-Free)	1000 Units / Tape & Reel
MM74HCT573MTC	TSSOP-20 WB, Case 948E	75 Units / Tube
MM74HCT573MTCX	(Pb-Free)	2500 Units / Tape & Reel
MM74HCT574WM	SOIC-20 WB, Case 751D-05	38 Units / Tube
MM74HCT574WMX	(Pb-Free and Halide-Free)	1000 Units / Tape & Reel
MM74HCT574MTC	TSSOP-20 WB, Case 948E (Pb-Free)	75 Units / Tube
MM74HCT574MTCX	TSSOP20, Case 948AQ-01 (Pb-Free)	2500 Units / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



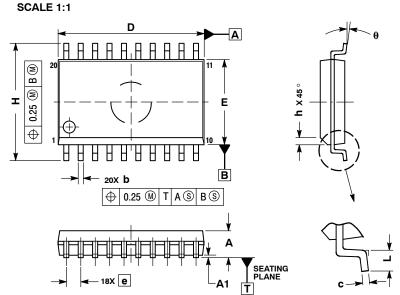
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

SOIC-20 WB CASE 751D-05

ISSUE H

DATE 22 APR 2015

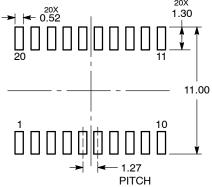




- DIMENSIONS ARE IN MILLIMETERS.
 INTERPRET DIMENSIONS AND TOLERANCES.
- PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD
- PROTRUSION.
 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL

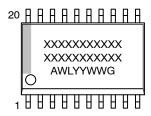
	MILLIMETERS		
DIM	MIN	MAX	
Α	2.35	2.65	
A1	0.10	0.25	
b	0.35	0.49	
С	0.23	0.32	
D	12.65	12.95	
E	7.40	7.60	
е	1.27 BSC		
Н	10.05	10.55	
h	0.25	0.75	
L	0.50	0.90	
Δ	0 0	7 0	

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code = Assembly Location

WL = Wafer Lot ΥY = Year WW = Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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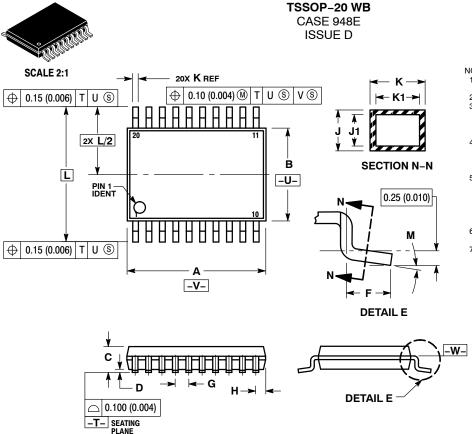
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^{*}For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



DATE 17 FEB 2016

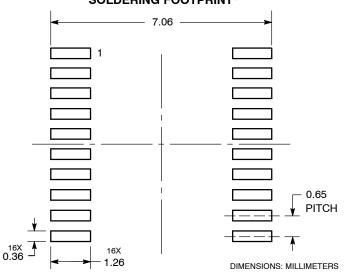
NOTES:

- NOTES:
 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT
- EXCEED 0.15 (0.006) PER SIDE.

 4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION.
 INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
 DIMENSION K DOES NOT INCLUDE
- DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K
 DIMENSION AT MAXIMUM MATERIAL CONDITION.
 TERMINAL NUMBERS ARE SHOWN FOR
- REFERENCE ONLY.
 DIMENSION A AND B ARE TO BE
 DETERMINED AT DATUM PLANE –W-.

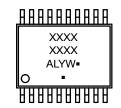
	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
Α	6.40	6.60	0.252	0.260
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
Н	0.27	0.37	0.011	0.015
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

RECOMMENDED SOLDERING FOOTPRINT*



^{*}For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC MARKING DIAGRAM*



= Assembly Location

= Wafer Lot

= Year

= Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ", may or may not be present. Some products may not follow the Generic Marking.

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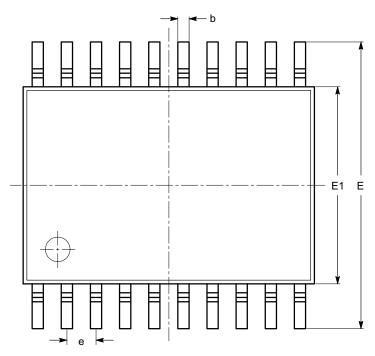


MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

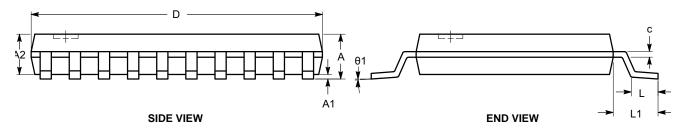
TSSOP20, 4.4x6.5 CASE 948AQ ISSUE A

DATE 19 MAR 2009



SYMBOL	MIN	NOM	MAX
Α			1.20
A1	0.05		0.15
A2	0.80		1.05
b	0.19		0.30
С	0.09		0.20
D	6.40	6.50	6.60
E	6.30	6.40	6.50
E1	4.30	4.40	4.50
е		0.65 BSC	
L	0.45	0.60	0.75
L1		1.00 REF	
θ	0°		8°

TOP VIEW



Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

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